

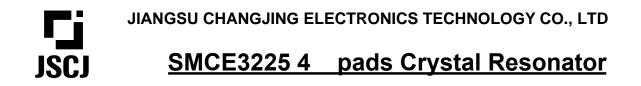
# 产品规格书

### SPECIFICATIONS FOR PRODUCT

| 产品类型 | TYPE | : | SMD3225               |
|------|------|---|-----------------------|
| 产品规格 | SPEC | : | 16MHz/3225/16PF/10PPM |
| 产品型号 | P/N  | : | CJ13-160001610A20     |
| 日期   | DATE | : | 2018/12/05            |

| 核准及签名      |            |            | 部バ      |
|------------|------------|------------|---------|
| R&D APPR.  | SIGNATURED |            | DEPT.   |
| 拟制         | 审核         | 批准         | 频率器件事业部 |
| ISSUE      | CHECK      | APPROVAL   |         |
| 王嘉诚        | 许秋菊        | 杨立新        |         |
| 2018/12/05 | 2018/12/05 | 2018/12/05 |         |

江 苏 长 晶 科 技 有 限 公 司 JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD 地址:中国江苏省南京江北新区产业技术研创园江淼路88号腾飞大厦C座13楼 Add: 13Th Floor, C Block, Tengfei Building, No. 88 Jiangmiao Rd. Pukou District, Nanjing City, Jiangsu Province, China



# CJ13-160001610A20

- 1. Scope:
- 1.1 This specification applies to the RoHS/SONY compliance quartz crystal unit with a frequency of 16MHz which will be used in crystal oscillator applications.
- 2. Construction:
- 2.1 Type of Quartz Resonator: SMCE3225 4pads

#### 3. Electrical Characteristics

| 3.1                | Nominal Frequency(f):  | 16MHz                  |
|--------------------|--|------------------------|
| 3.2                | Load Capacitance(C <sub>L</sub> ):   | 16pF                   |
| 3.3                | Frequency Tolerance(△f/f):   | ±10ppm                 |
| 3.4                | Frequency Temperature Stability:   | ±20ppm                 |
| 3.5                | Resonance Resistance(ohm):   | 80ohms Max             |
| 3.6                | Osc mode:  | Fundamental mode       |
|                    |  |                        |
| 3.7                | Shunt Capacitance(C <sub>0</sub> ):  | <2pF                   |
|                    | Shunt Capacitance(C <sub>0</sub> ):<br>Drive Level(D <sub>L</sub> ):             | <2pF<br>< 100µW        |
| 3.8                |  |                        |
| 3.8<br>3.9         | Drive Level(D <sub>L</sub> ):  | -<br>< 100μW           |
| 3.8<br>3.9<br>3.10 | Drive Level(D <sub>L</sub> ):<br>Operating Temperature Range(T <sub>OPR</sub> ): | < 100µW<br>-20 to + 70 |

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### 4. Reliability Specifications

This is the quality control and quality assurance and reliability tests performance data for the RoHS/

SONYcompliance 16MHz SMCE3225 4pads crystal resonators

related to the specification and approval sheet provided by JSCJ .

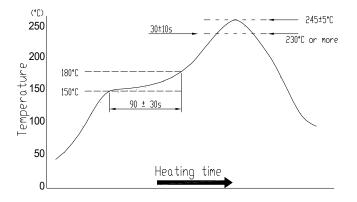
Standard test condition (TEMP.: 20±5°C. Relative humidity: 65±20%)

For any discrepancy in GO/NG, test will be done at TEMP.25±2°C, R.H. 65±5%.

| NO.  | PROCESS   | SPECIFICATION  | TEST METHOD   |
|------|---|--|---|
| 4.1  | Temperature Cycle(GB/T<br>2423.22-2002, Method Nb)                  | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.                                  | 10 cycles from -55°C to 125°C. Measurement taken after DUT being left at room temperature for 24±2 hours.   |
| 4.2  | Low Temperature Storage<br>(GB/T 2423.1-2001, Method<br>Aa)         | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.                                  | Spending 72 hrs at -55°C±3°C constant<br>temperature. Measurement taken after DUT being<br>left at room temperature for 24±2 hours.   |
| 4.3  | High Temperature Storage<br>(GB/T 2423.2-2001, Method<br>Ba)        | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.                                  | Spending 72 hrs at 125°C±3°C constant<br>temperature. Measurement taken after DUT being<br>left at room temperature for 24±2 hours.   |
| 4.4  | Humidity (GB/T 2423.3-<br>2006, Method Cab)                         | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.                                  | Spending 96 hrs at 40 °C $\pm$ 3 °C, with 93 %R.H,<br>Then keep the DUT in dry oven at 40 $\pm$ 5 °C for 24<br>hour. Measurement taken after DUT being left at<br>room temperature for 1 to 2 hours.  |
| 4.5  | Vibration(GB/T 2423.10-<br>1995, Method Fc)                         | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.                                  | Apply 0.75mm vibration at sweep frequency $10\sim$ 500 Hz, 10 cycles in each direction of 3 axis.<br>Measurement taken after 1 hour.  |
| 4.6  | Shock (GB/T 2423.5-1995,<br>Method Ea)                              | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.and<br>exhibit no visible damage. | Peak 1000m/s2, normal width 6ms half sine wave<br>form, 3.7m/s, 3 perpendicular axis of samples, 3<br>cycles / direction, total 18 cycles. Measurement<br>taken after 1 hour.   |
| 4.7  | Drop (GB/T 2423.8-1995,<br>Method Ed)                               | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.and<br>exhibit no visible damage. | Free drop to the steel plate with thickness of 3 mm from 1.00 m heights for 3 times.  |
| 4.8  | Solderability (IEC60068-2-<br>58,Test Td:)                          | Terminals shall be covered more then 95% with solder.  | Passed through the re-flow oven under the following condition. Preheat 150 to $180^{\circ}$ C for 60 to 120sec, and soldering time for $20s \pm 5s$ at $235^{\circ}$ C, peak soldering time for $10s \pm 1s$ betweein 240 and 250°C. There is no need to do functional test. 8-12X magnifier. |
| 4.9  | Terminal Strength (JIS-C-<br>6429 Method 1 & 2)                     | No visible damage  | Mount on a glass-epoxy board (100x50x1.6mm),<br>then bend to 2mm displacement (velocity<br>1mm/sec) and keep for 5 seconds. or pulling force<br>1.8kg for at least 60 seconds.  |
|      |   |  |   |
| 4.10 | Resistance to Soldering<br>Heat (IEC60068-2-58,Test<br>Td: Table 4) | Frequency change after test ≤±<br>5ppm.Resonance resistance<br>change after test ≤10ohms.                                  | Passed through the re-flow oven under the<br>following condition. Preheat 150 to 180°C for 60 to<br>120sec, and sodering time for 60s max at 235°C,<br>peak soldering time for 20s max at 265°C max.<br>Measurement taken after DUT being left at room<br>temperature for at least 2 hours.   |
|      |   |  |   |
| 4.11 | OTHERS  |  |   |

5. Recommended Reflow soldering condition (SMD) Solder profile

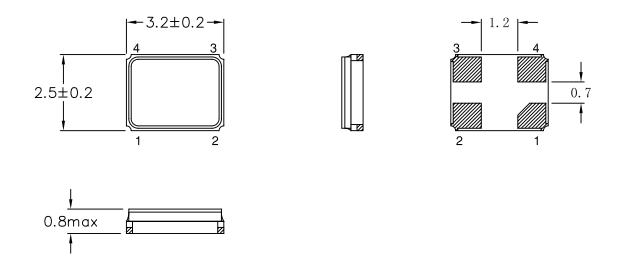
Peak: 245±5°C Soldering zone: 230°C or more, 30±10s. Pre-heating zone 1: 150 $\sim$  180°C, 90±30s



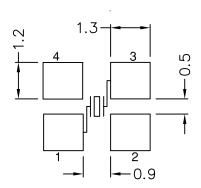
Temperature profile for reflow soldering

6. Soldering iron method

Bit temperature:  $350\pm10$  °C Application time of soldering iron:3+1 s. For other procedures, refer to IEC 60068-2-20.

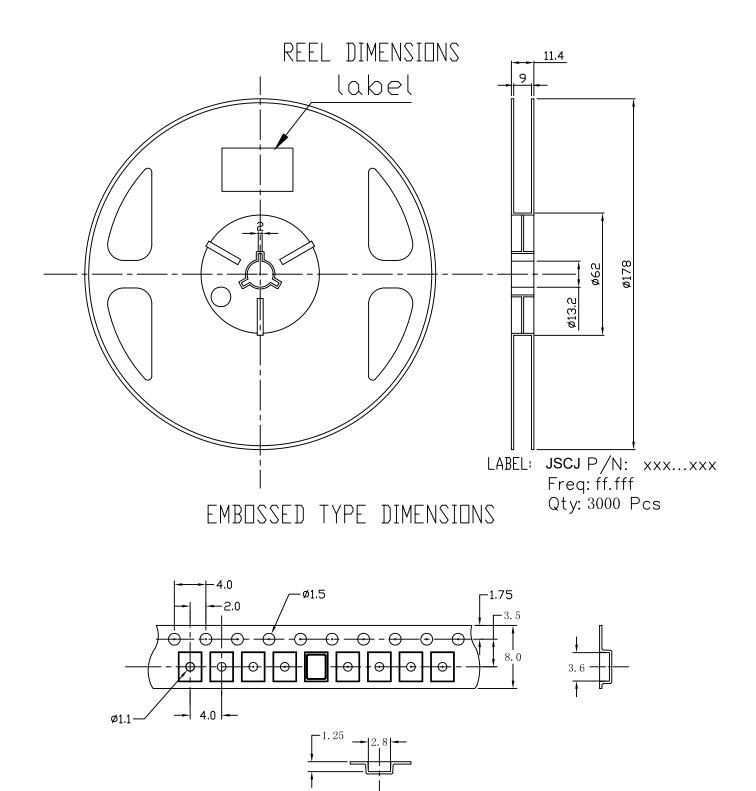


#### Suggested Pad Layout



#### NOTICE

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